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**Practitioner's Docket No.:S&ZIO030901**

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**Mail Stop: Non Fee Amendment**

Laurence A. Greenberg

June 28, 2005
Date

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| | | |
|---|---|---|
| Application No.: | 10/679,170 | Confirmation No.: 3954 |
| Applicant | : | Frank Daeche, et al. |
| Filed | : | October 2, 2003 |
| Title | : | Method for Manufacturing a Housing for a Chip having a Micromechanical Structure |
| Art Unit | : | 1765 |
| Examiner | : | Kin Chan Chen |
| **Customer No.:** | : | **24131** |

A M E N D M E N T

S i r :

Responsive to the Office action dated June 21, 2005, kindly amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 4 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.